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N08L1618C2A

Advance Information

8*Mb Ultra-Low Power Asynchronous CMOS SRAM* 512K × 16bit

Overview

The N08L1618C2A is an integrated memory device containing a 8 Mbit Static Random Access Memory organized as 524,288 words by 16 bits. The device is designed and fabricated using NanoAmp's advanced CMOS technology to provide both high-speed performance and ultra-low power. The device operates with two chip enable (CE1 and CE2) controls and output enable (OE) to allow for easy memory expansion. Byte controls (UB and LB) allow the upper and lower bytes to be accessed independently and can also be used to deselect the device. The N08L1618C2A is optimal for various applications where low-power is critical such as battery backup and hand-held devices. The device can operate over a very wide

temperature range of -40°C to +85°C and is available in JEDEC standard packages compatible with other standard 512Kb x 16 SRAMs

Features

- Single Wide Power Supply Range 1.65 to 2.2 Volts
- Very low standby current 0.5µA at 1.8V (Typical)
- Very low operating current 1.0mA at 1.8V and 1µs (Typical)
- Very low Page Mode operating current 0.5mA at 1.8V and 1µs (Typical)
- Simple memory control Dual Chip Enables (CE1 and CE2) Byte control for independent byte operation Output Enable (OE) for memory expansion
- Low voltage data retention Vcc = 1.2V
- Very fast output enable access time 25ns OE access time
- Very fast Page Mode access time t_{AAP} = 25ns
- Automatic power down to standby mode
- TTL compatible three-state output driver

| Part Number | Package Type | Operating Temperature | Power Supply (Vcc) | Speed | Standby Current (I _{SB}), Typical | Operating Current (Icc), Typical | |
|---------------|----------------|--------------------------|-----------------------|--------------|---|--|--|
| N08L1618C2AB | 48 - BGA | | 1.65V - 2.2V | 70ns @ 1.8V | 0.5 μA | 1 mA @ 1MHz | |
| N08L1618C2AB2 | 48 - BGA Green | -40°C to +85°C | 1.050 - 2.20 | 85ns @ 1.65V | 0.5 μΑ | | |

Pin Configuration

| | 1 | 2 | 3 | 4 | 5 | 6 | |
|------------------|--------------------------|-------------------|-----------------|-----------------|------------------|----------------------------|--|
| А | LB | OE | A ₀ | A ₁ | A ₂ | CE2 | |
| В | I/O ₈ | UB | A ₃ | A ₄ | CE1 | I/O ₀ | |
| С | I/O ₉ | I/O ₁₀ | A ₅ | A ₆ | I/O ₁ | I/O ₂ | |
| D | \mathbf{v}_{ss} | I/O ₁₁ | A ₁₇ | A ₇ | I/O ₃ | \mathbf{v}_{cc} | |
| Е | v_{cc} | I/O ₁₂ | NC | A ₁₆ | I/O ₄ | \mathbf{v}_{ss} | |
| F | I/O ₁₄ | I/O ₁₃ | A ₁₄ | A ₁₅ | I/O ₅ | I/O ₆ | |
| G | I/O ₁₅ | NC | A ₁₂ | A ₁₃ | WE | I/O ₇ | |
| Н | A ₁₈ | A ₈ | A ₉ | A ₁₀ | A ₁₁ | NC | |
| 48 Pin BGA (top) | | | | | | | |
| | 8 x 10 mm | | | | | | |

Pin Descriptions

| Pin Name | Pin Function |
|-------------------------------------|-------------------------|
| A ₀ -A ₁₈ | Address Inputs |
| WE | Write Enable Input |
| CE1, CE2 | Chip Enable Input |
| OE | Output Enable Input |
| LB | Lower Byte Enable Input |
| UB | Upper Byte Enable Input |
| I/O ₀ -I/O ₁₅ | Data Inputs/Outputs |
| V _{CC} | Power |
| V _{SS} | Ground |
| NC | Not Connected |

(DOC# 14-02-019 REV F ECN# 01-1280)

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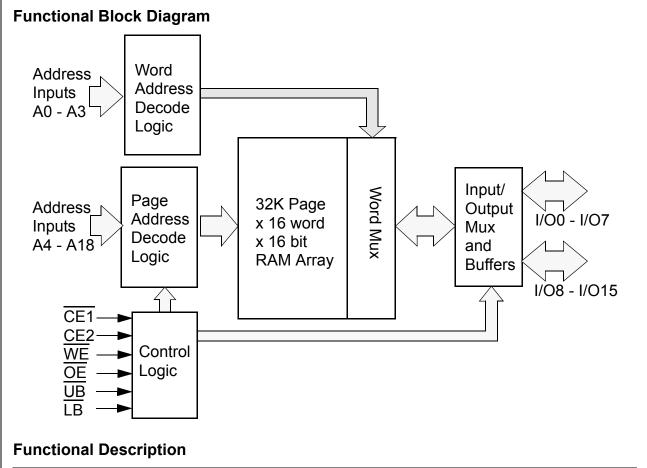
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| CE1 | CE2 | WE | OE | UB | LB | 1/0 ₀ - 1/0 ₁₅ ¹ | MODE | POWER |
|-----|-----|----|----------------|----------------|----------------|---|-----------------------------|--------------------------------|
| Н | Х | Х | Х | Х | Х | High Z | High Z Standby ² | |
| Х | L | Х | Х | Х | Х | High Z | Standby ² | Standby |
| Х | Х | Х | Х | Н | Н | High Z | Standby ² | Standby |
| L | Н | L | X ³ | L^1 | L ¹ | Data In | Write ³ | Active -> Standby ⁴ |
| L | Н | Н | L | L^1 | L ¹ | Data Out | Read | Active -> Standby ⁴ |
| L | Н | Н | Н | L ¹ | L ¹ | High Z | High Z Active S | |

1. When $\overline{\text{UB}}$ and $\overline{\text{LB}}$ are in select mode (low), I/O₀ - I/O₁₅ are affected as shown. When $\overline{\text{LB}}$ only is in the select mode only I/O₀ - I/O₇ are affected as shown. When $\overline{\text{UB}}$ is in the select mode only I/O₈ - I/O₁₅ are affected as shown.

2. When the device is in standby mode, control inputs (\overline{WE} , \overline{OE} , \overline{UB} , and \overline{LB}), address inputs and data input/outputs are internally isolated from any external influence and disabled from exerting any influence externally.

3. When WE is invoked, the OE input is internally disabled and has no effect on the circuit.

4. The device will consume active power in this mode whenever addresses are changed. Data inputs are internally isolated from any expernal influence.

Capacitance¹

| Item | Symbol | Test Condition | Min | Мах | Unit |
|-------------------|------------------|--|-----|-----|------|
| Input Capacitance | C _{IN} | V _{IN} = 0V, f = 1 MHz, T _A = 25°C | | 8 | pF |
| I/O Capacitance | C _{I/O} | V _{IN} = 0V, f = 1 MHz, T _A = 25°C | | 8 | pF |

1. These parameters are verified in device characterization and are not 100% tested

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Absolute Maximum Ratings¹

| Item | Symbol | Rating | Unit |
|---|---------------------|------------------------------|------|
| Voltage on any pin relative to V_{SS} | V _{IN,OUT} | –0.3 to V _{CC} +0.3 | V |
| Voltage on V_{CC} Supply Relative to V_{SS} | V _{CC} | -0.3 to 3.0 | V |
| Power Dissipation | PD | 500 | mW |
| Storage Temperature | T _{STG} | -40 to 125 | °C |
| Operating Temperature | T _A | -40 to +85 | °C |
| Soldering Temperature and Time | T _{SOLDER} | 260 ^o C, 10sec | °C |

1. Stresses greater than those listed above may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operating section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Operating Characteristics (Over Specified Temperature Range)

| Item | Symbol | Test Conditions | Min. | Typ ¹ | Мах | Unit |
|--|------------------|---|----------------------|------------------|----------------------|------|
| Supply Voltage | V _{CC} | | 1.65 | 1.8 | 2.2 | V |
| Data Retention Voltage | V_{DR} | Chip Disabled ³ | 1.2 | | | V |
| Input High Voltage | V_{IH} | | 0.7V _{CC} | | V _{CC} +0.3 | V |
| Input Low Voltage | V _{IL} | | -0.3 | | 0.3V _{CC} | V |
| Output High Voltage | V _{OH} | I _{OH} = 0.2mA | V _{CC} -0.2 | | | V |
| Output Low Voltage | V _{OL} | I _{OL} = -0.2mA | | | 0.2 | V |
| Input Leakage Current | ILI | V_{IN} = 0 to V_{CC} | | | 0.5 | μA |
| Output Leakage Current | I _{LO} | $\overline{OE} = V_{IH}$ or Chip Disabled | | | 0.5 | μA |
| Read/Write Operating Supply Current @ 1 µs Cycle Time ² | I _{CC1} | V_{CC} =2.2 V, V_{IN} = V_{IH} or V_{IL} Chip Enabled, I_{OUT} = 0 | | 1.0 | 3.0 | mA |
| Read/Write Operating Supply Current @ 70 ns Cycle Time ² | I _{CC2} | V_{CC} =2.2 V, V_{IN} = V_{IH} or V_{IL} Chip Enabled, I_{OUT} = 0 | | 10.0 | 14.0 | mA |
| Page Mode Operating Supply Current @ 70 ns Cycle Time ² | I _{CC3} | V_{CC} =2.2 V, V_{IN} = V_{IH} or V_{IL} Chip Enabled, I_{OUT} = 0 | | 0.5 | 3.0 | mA |
| Read/Write Quiescent Operating Sup- ply Current ³ | I _{CC4} | V_{CC} =2.2 V, V_{IN} = V_{IH} or V_{IL} Chip Enabled, I_{OUT} = 0, f = 0 | | | 20 | μΑ |
| Maximum Standby Current ³ | I _{SB1} | V _{IN} = V _{CC} or 0V Chip Disabled t _A = 85 ^o C, V _{CC} = 2.2 V | | 0.5 | 20.0 | μΑ |
| Maximum Data Retention Current ³ | I _{DR} | Vcc = 1.2V, $V_{IN} = V_{CC}$ or 0 Chip Disabled, $t_A = 85^{\circ}C$ | | | 10 | μA |

1. Typical values are measured at Vcc=Vcc Typ., T_A=25°C and not 100% tested.

2. This parameter is specified with the outputs disabled to avoid external loading effects. The user must add current required to drive output capacitance expected in the actual system.

3. This device assumes a standby mode if the chip is disabled (CE1 high or CE2 low). In order to achieve low standby current all inputs must be within 0.2 volts of either VCC or VSS.

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| Power Savings with Pa | ge Mode Operation (WE = V _{IH}) | |
|-------------------------|---|--|
| Page Address (A4 - A18) | Open page | |
| Word Address (A0 - A3) | Word 1 Word 2 Word 16 V | |
| CE1 | | |
| CE2 | | |
| OE | | |
| LB, UB | | |

Note: Page mode operation is a method of addressing the SRAM to save operating current. The internal organization of the SRAM is optimized to allow this unique operating mode to be used as a valuable power saving feature.

The only thing that needs to be done is to address the SRAM in a manner that the internal page is left open and 16-bit words of data are read from the open page. By treating addresses A0-A3 as the least significant bits and addressing the 16 words within the open page, power is reduced to the page mode value which is considerably lower than standard operating currents for low power SRAMs.

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Timing Test Conditions

| Item | |
|--|---|
| Input Pulse Level | 0.1V _{CC} to 0.9 V _{CC} |
| Input Rise and Fall Time | 5ns |
| Input and Output Timing Reference Levels | 0.5 V _{CC} |
| Output Load | 30pF |
| Operating Temperature | -40 to +85 °C |

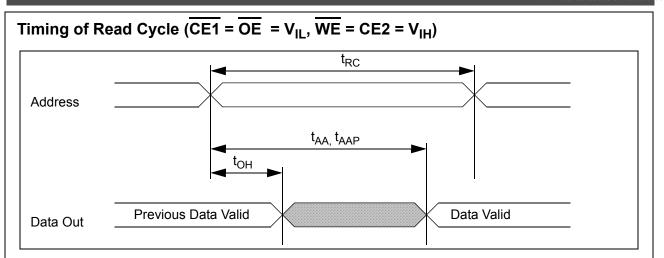
Timing

| | O much a l | 1.65 | - 2.2 V | 1.8 - | 2.2 V | 11 |
|--------------------------------------|---------------------------------------|------|---------|-------|-------|-------|
| Item | Symbol | Min. | Max. | Min. | Max. | Units |
| Read Cycle Time | t _{RC} | 85 | | 70 | | ns |
| Address Access Time (Random Access) | t _{AA} | | 85 | | 70 | ns |
| Address Access Time (Page Mode) | t _{AAP} | | 30 | | 25 | ns |
| Chip Enable to Valid Output | t _{co} | | 85 | | 70 | ns |
| Output Enable to Valid Output | t _{OE} | | 30 | | 25 | ns |
| Byte Select to Valid Output | t _{LB} , t _{UB} | | 85 | | 70 | ns |
| Chip Enable to Low-Z output | t _{LZ} | 10 | | 10 | | ns |
| Output Enable to Low-Z Output | t _{OLZ} | 5 | | 5 | | ns |
| Byte Select to Low-Z Output | t _{LBZ} , t _{UBZ} | 10 | | 10 | | ns |
| Chip Disable to High-Z Output | t _{HZ} | 0 | 20 | 0 | 20 | ns |
| Output Disable to High-Z Output | t _{OHZ} | 0 | 20 | 0 | 20 | ns |
| Byte Select Disable to High-Z Output | t _{LBHZ} , t _{UBHZ} | 0 | 20 | 0 | 20 | ns |
| Output Hold from Address Change | t _{он} | 5 | | 5 | | ns |
| Write Cycle Time | t _{WC} | 85 | | 70 | | ns |
| Chip Enable to End of Write | t _{CW} | 50 | | 50 | | ns |
| Address Valid to End of Write | t _{AW} | 50 | | 50 | | ns |
| Byte Select to End of Write | t _{LBW} , t _{UBW} | 50 | | 50 | | ns |
| Write Pulse Width | t _{WP} | 40 | | 40 | | ns |
| Address Setup Time | t _{AS} | 0 | | 0 | | ns |
| Write Recovery Time | t _{WR} | 0 | | 0 | | ns |
| Write to High-Z Output | t _{WHZ} | | 20 | | 20 | ns |
| Data to Write Time Overlap | t _{DW} | 40 | | 40 | | ns |
| Data Hold from Write Time | t _{DH} | 0 | | 0 | | ns |
| End Write to Low-Z Output | t _{OW} | 5 | | 5 | | ns |

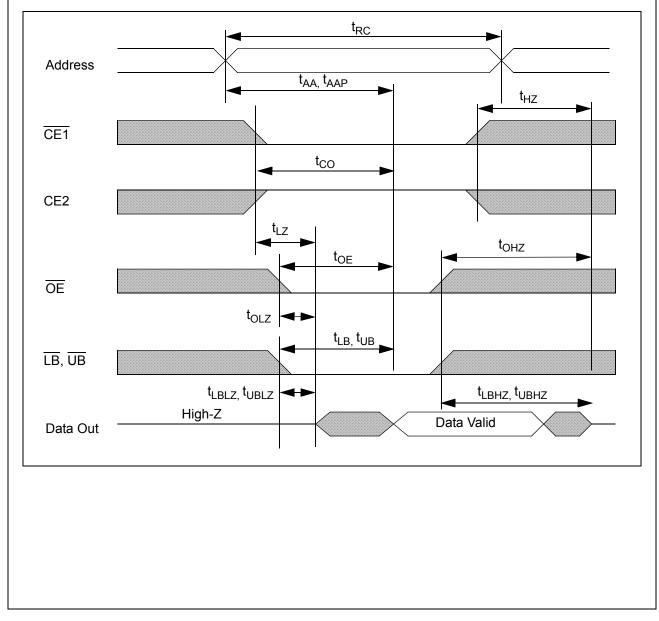
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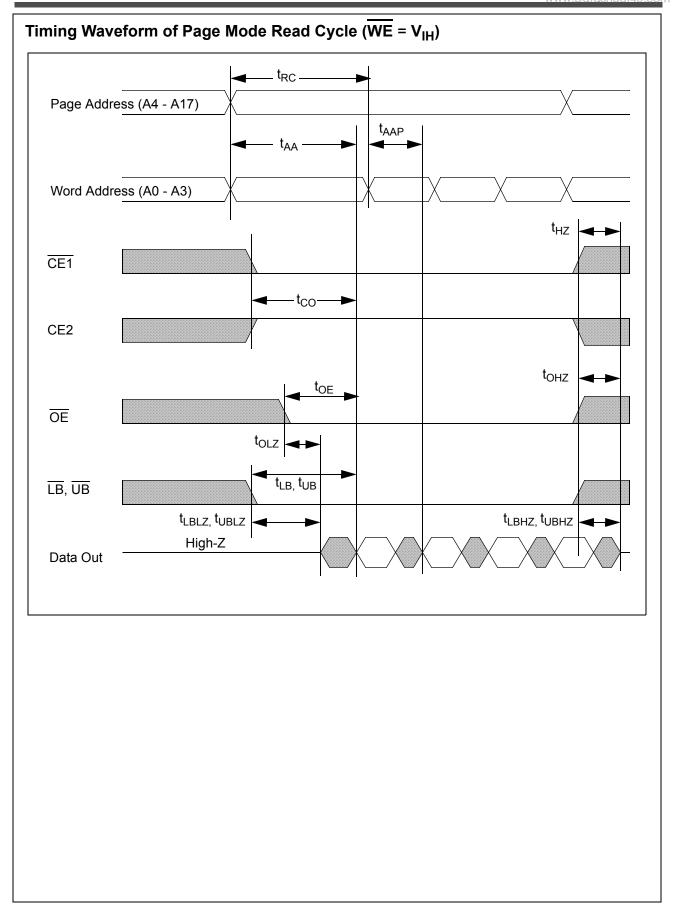


Timing Waveform of Read Cycle (WE=VIH)



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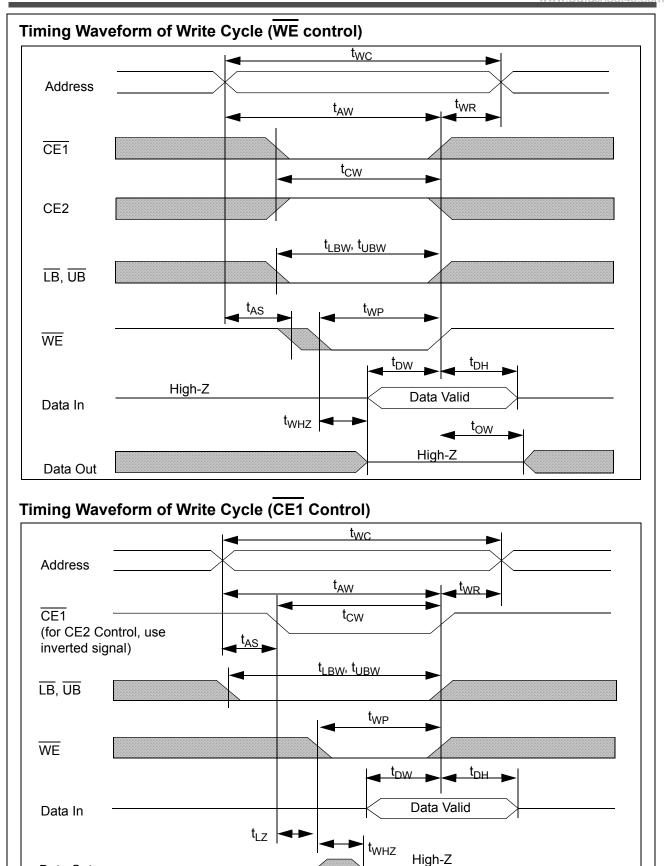
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Data Out

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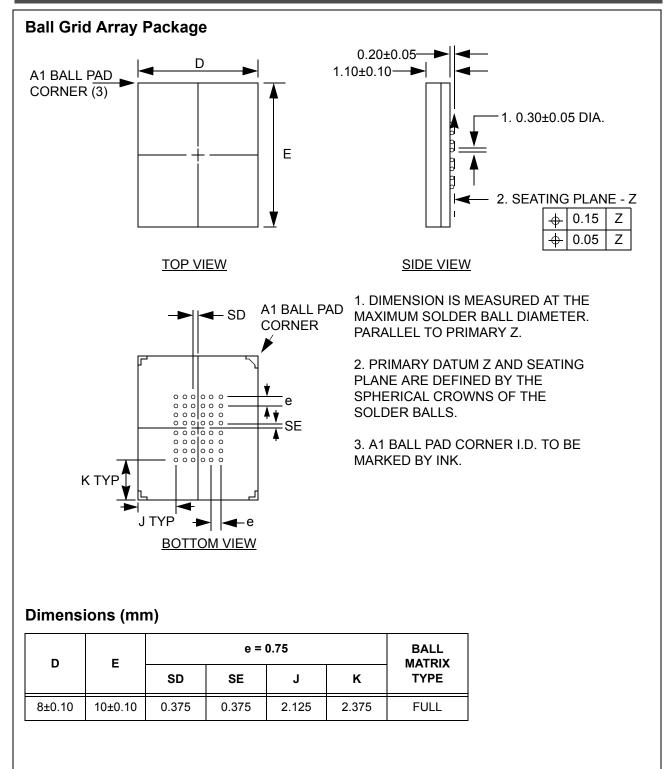
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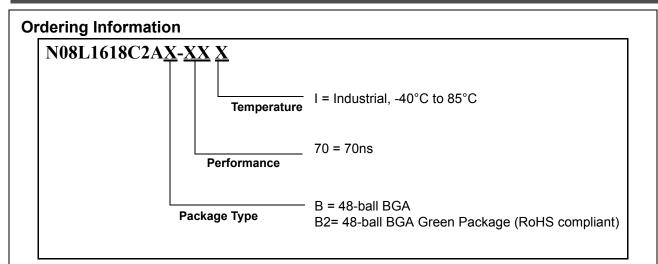
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Revision History

| Revision | Date | Change Description |
|----------|-----------|---|
| A | Jan. 2001 | Initial Advance Release |
| В | Mar. 2001 | Corrected voltage in Timing table |
| С | Dec. 2001 | Part number change from EM512W16, modified Overview and Features, added Page Mode Operatin diagram, revised Operating Characteristics table, Package diagram, Functional Description table and Ordering Information diagram |
| D | Nov. 2002 | Replaced Isb and Icc on Product Family table with typical values |
| E | Oct. 2004 | Added Green Package Option |
| F | Dec. 2005 | Added RoHS compliant on green packages |

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